

## PATENT ASSIGNMENT COVER SHEET

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<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT	
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT	
<b>CONVEYING PARTY DATA</b>		
	<b>Name</b>	<b>Execution Date</b>
	DAISUKE TSUNAMI	03/29/2019
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<b>PROPERTY NUMBERS Total: 1</b>		
<b>Property Type</b>	<b>Number</b>	
<b>Application Number:</b>	16472082	
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<b>ATTORNEY DOCKET NUMBER:</b>	004700-ME0372	
<b>NAME OF SUBMITTER:</b>	TIM L. BRACKETT, JR.	
<b>SIGNATURE:</b>	/Tim L. Brackett, Jr. /	
<b>DATE SIGNED:</b>	06/20/2019	
	This document serves as an Oath/Declaration (37 CFR 1.63).	
<b>Total Attachments: 2</b>		
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COMBINED DECLARATION (37 CFR 1.63) AND ASSIGNMENT OF APPLICATION  
FOR UNITED STATES LETTERS PATENT

Title of Invention:

SEMICONDUCTOR DEVICE MANUFACTURING METHOD AND SEMICONDUCTOR DEVICE

私は、以下に記名された発明者として、ここに下記  
の通り宣言する： As a below named inventor, I hereby declare that:

本宣言書は、以下の出願に対するものである：

This declaration is directed to:

- ☐ 添付された出願、あるいは、  
☐ 米国出願番号またはPCT国際出願番号は、  
\_\_\_\_\_であり、且つ

- ☐ The attached application, or  
☒ United States application or PCT international  
application number PCT/JP2017/012100  
filed on March 24, 2017

\_\_\_\_\_の日に出願された出願（該  
当する場合）

上記出願書（明細書及び図面）は、私が作成したもの  
か、あるいは私がその作成を許可したものである。

The above-identified application was made or authorized to  
be made by me.

私は、本米国出願の請求範囲で記載された発明に対  
する原発明者であるか、或いは、原共同発明者であ  
ると信じている。

I believe that I am the original inventor or an original joint  
inventor of a claimed invention in the application.

私は、ここでの宣誓または陳述において故意に偽り  
を述べた場合、合衆国法典第18巻第1001条に基づ  
き、罰金あるいは5年以下の懲役、または、両方の  
懲罰を受けることを認める。

I hereby acknowledge that any willful false statement made  
in this declaration is punishable under 18 U.S.C. 1001 by fine  
or imprisonment of not more than five (5) years, or both.

STATEMENT OF ACCURATE TRANSLATION IN  
ACCORDANCE WITH 37 CFR 1.69(b):

The Declaration and Assignment for Patent and Design  
Applications is an accurate translation of the corresponding  
English language Declaration and Assignment for Patent  
and Design Applications

Signature: \_\_\_\_\_

Date: 11/15/2012

651792US01  
T6637US



651792US01  
T6637US

Attorney Docket No. \_\_\_\_\_

**WHEREAS** the undersigned, hereinafter referred to as the assignor, has invented a certain improvement relating to the above identified application.

The inventor declaration for said application is combined herewith.

☒ said application to be filed in the United States Patent and Trademark Office;

☐ said application having been filed in the United States Patent and Trademark Office on, \_\_\_\_\_ authorization being hereby given to the practitioners associated with **STUDEBAKER & BRACKETT PC's** **CUSTOMER NUMBER 78198**, to insert here in parentheses (Application Serial No. \_\_\_\_\_) the application serial number of said application when known;

☐ said application having been filed under the Patent Cooperation Treaty on \_\_\_\_\_ as Serial No. \_\_\_\_\_, the United States of America being designated.

**AND WHEREAS** Mitsubishi Electric Corporation of 7-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310, Japan, hereinafter referred to as the assignee, is desirous of acquiring the entire right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof;

**NOW**, that for and in consideration of One Dollar (\$1.00), and other good and valuable consideration paid by said assignee to said assignor, the receipt of which is hereby acknowledged, said assignor hereby assigns, sells and transfers to said assignee, and said assignee's successors and assigns, the full and exclusive right, title and interest in and to said application, including any and all divisions and continuations thereof, and in and to said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof; said assignee, and said assignee's successors and assigns, to have, hold, exercise and enjoy the said application, including any and all divisions and continuations thereof, and the said invention and any and all patents which may be granted therefor, including any and all renewals, reissues and prolongations thereof, with all the rights, powers, privileges and advantages in anywise arising from or appertaining thereto, for and during the term or terms of any and all such patents when granted, including any and all renewals, reissues and prolongations thereof, for the use and benefit of said assignee, and said assignee's successors and assigns, in as ample and beneficial a manner as the said assignor might or could have held and enjoyed the same, if this assignment had not been made.

**AND** said assignor hereby agrees to perform, upon the request of said assignee, or said assignee's successors or assigns, any and all acts relating to the obtaining or to the asserting of said patents, including any and all renewals, reissues and prolongations thereof.

**AND** said assignor authorizes and requests the Commissioner of Patents and Trademarks to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said assignee, and said assignee's successors and assigns, in accordance herewith.

The undersigned hereby grants the law firm of **STUDEBAKER & BRACKETT PC** the power to insert on the Assignment portion of this combined Declaration and Assignment any further identification which may be necessary or desirable in order to comply with the rules of the U.S. Patent and Trademark Office for recordation of this document.

This combined Declaration and Assignment has been executed by the undersigned on the date opposite the undersigned name.

発明者氏名/ Legal Name of Inventor Daisuke TSUNAMI	
発明者の署名/ Signature Daisuke TSUNAMI	日付/ Date March 29, 2019